Overview

HP Elite Dragonfly 13.5 inch G3 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Ambient Light and Color Sensor
- 3. IR LED & Cam
- 4. Webcam
- 5. Webcam LED

- 6. Clickpad
- 7. LED Indicator
- **8.** Thunderbolt[™] 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)¹
- 9. Nano SIM card slot (WWAN Configurations Only)
- **10.** HDMI 2.0
- 1. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4

Overview



- 1. Power Button
- 2. Audio Combo Jack
- **3.** SuperSpeed USB Type-A 5Gbps signaling rate (Charging port) (USB 3.2 Gen 1)
- **4.** Thunderbolt[™] 4 with USB4 Type-C[®] 40Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)¹
- 1. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4

Right

- 5. LED Indicator
- 6. Nano Security Lock Slot (Lock sold separately)
- 7. Fingerprint Sensor

Overview

At a Glance

- Preinstalled with Windows 11 versions or FreeDOS
- A new lightweight clamshell ultra slim design that starts at less than 1kg.
- The Elite Dragonfly G3 offers a choice of colors: Slate Blue or Natural Silver
- New 3:2 aspect ratio screen reduces the need to scroll by showing more vertical content than 16:9. Both touch and non-touch panels are offered.
- 12th Generation Intel® Core™ i5. i7 U series. (ten-core)
- New 5MP camera with HP Auto Frame allows you around a little without losing viewers' attention during video calls
- New LPDDR5 memory (up to 32GB) and PCI Gen4 SSDs provide fast access to your work.
- Choice of displays:
 - 34.3 cm (13.5") diagonal, BV WUXGA+ (1920x1280), WLED-backlit, 400 nits, 100% sRGB, non-touch with HP Eye Ease 34.3 cm (13.5") diagonal, AG WUXGA+ (1920x1280), WLED-backlit, 1000 nits, 100% sRGB, HP Sure View Reflect, non-touch with HP Eye Ease
 - 34.3 cm (13.5") diagonal, BV WUXGA+ (1920x1280), WLED-backlit, 400 nits, 100% sRGB, touch with HP Eye Ease 34.3 cm (13.5") diagonal, AG WUXGA+ (1920x1280), WLED-backlit, 400 nits, 100% sRGB, touch with HP Eye Ease 34.3 cm (13.5") diagonal, BV WUXGA+ (1920x1280), WLED-backlit, 1000 nits, 100% sRGB, HP Sure View Reflect, touch with HP Eye Ease
 - 34.3 cm (13.5") diagonal, 3K2K, OLED (3000x2000), 400 nits, 100% DCI P3, touch with HP Eye Ease
- Choose from 45Whr or 68Whr battery options
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense.
- Larger Clickpad surface for easier, more intuitive input
- Connectivity with optional Intel® 5000 5G/WWAN available world-wide, and Thunderbolt™ Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5

NOTE: See important legal disclosures for all listed specs in their respective features sections.



QuickSpecs

Technical Specifications

PRODUCT NAME

HP Elite Dragonfly 13.5 inch G3 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 11 Pro 1

Windows 11 Pro Education 1

Windows 11 Home - HP recommends Windows 11 Pro for Business 1

Windows 11 Home Single Language – HP recommends Windows 11 Pro for Business 1

Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing

Agreement) 1

Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) 1,2

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Processor		Number of Thre	Threads L3	L3	Max Turbo Frequency		Base Frequency		Intel SIPP/vPro®		
3,4,5,6,7,8	Cores	P-cores				Cache	P-cores	E-cores	P- cores	E- cores	Enterprise
Intel® Core™ i7-1265U	10	2	8	12	12MB	4.8 GHz	3.6 GHz	1.8 GHz	1.3 GHz	Х	
Intel® Core™ i7-1255U	10	2	8	12	12MB	4.7 GHz	3.5 GHz	1.7 GHz	1.2 GHz		
Intel® Core™ i5-1245U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.2 GHz	1.2 GHz	Х	
Intel® Core™ i5-1235U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.3 GHz	0.9 GHz		

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.



- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.
- 6. Boost clock frequency performance varies depending on hardware, software and overall system configuration.
- 7. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com
- 8. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® Xe Graphics 9

Supports

Support HD decode, DX12, HDMI 2.0b 10

9. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.

10. HD content required to view HD images.

DISPLAY

Non-Touch

34.3 cm (13.5") diagonal, WUXGA+, IPS BrightView, micro-edge, 400 nits, sRGB 100% eDP 1.4+PSR,Ambient Light Sensor + Ambient Color Sensor (1920 x 1280) with HP Eye Ease ^{10,11}

34.3 cm (13.5") diagonal, WUXGA+ ,UWVA anti-glare, micro-edge, 1000 nits, HP Sure View integrated privacy screen, eDP 1.3+PSR, Ambient Light Sensor + Ambient Color Sensor (1920 x 1280) with HP Eye Ease 10,12,13,14

Touch

34.3 cm (13.5") diagonal, 3K2K, OLED OLED touch, IPS BrightView, micro-edge, 400 nits, DCI-P3 100% eDP 1.4+PSR, Ambient Light Sensor + Ambient Color Sensor (3000 x 2000) with HP Eye Ease 10,12,13,14

34.3 cm (13.5") diagonal, WUXGA+, touch, IPS anti-glare, micro-edge, 400 nits, sRGB 100% eDP 1.4+PSR, Ambient Light Sensor + Ambient Color Sensor (1920 x 1280) with HP Eye Ease 10,12,13,14

34.3 cm (13.5") diagonal, WUXGA+, touch, UWVA BrightView, micro-edge, 1000 nits, HP Sure View integrated privacy screen, eDP 1.3+PSR, Ambient Light Sensor + Ambient Color Sensor (1920 x 1280) with HP Eye Ease^{10,11,12,13,14}

34.3 cm (13.5") diagonal, WUXGA+, touch, IPS BrightView, micro-edge, 400 nits, sRGB 100% eDP 1.4+PSR, Ambient Light Sensor + Ambient Color Sensor (1920 x 1280) with HP Eye Ease^{10,11,12,14}



QuickSpecs

Technical Specifications

Display Size (Diagonal)

13.5" 34.3 cm (13.5")

- 10. HD content required to view HD images.
- 11. Sold separately or as an optional feature.
- 12. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 13. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 14. Actual brightness will be lower with touchscreen or HP Sure View.

DOCKING (Sold Separately)

Docking station model #1 HP Thunderholt Dock G2 Docking station model #2 HP USB-C Dock G5

Docking station model #3 HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 42.

STORAGE AND DRIVES

Primary Storage 2 TB PCIe® NVMe™ TLC Solid State Drive 15 1 TB PCIe® NVMe™ TLC Solid State Drive 15 512 GB PCIe® NVMe™ TLC Self Encrypted OPAL2 Solid State Drive 15 512 GB PCIe® NVMe™ TLC Solid State Drive 15 512 GB PCIe® NVMe™ M.2 SSD 15 256 GB PCIe® NVMe™ TLC Self Encrypted OPAL2 Solid State Drive 15 256 GB PCIe® NVMe™ TLC single-sided Solid State Drive 15 256 GB PCIe® NVMe™ M.2 SSD 15

15. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

MEMORY

Maximum Memory

32 GB LPDDR5-4800 SDRAM 16

Memory

32 GB LPDDR5-4800 SDRAM 16 16 GB LPDDR5-4800 SDRAM 16 8 GB LPDDR5-4800 SDRAM 16

Memory Slots



LPDDR5, system runs at 4800 ¹⁶ Supports Dual Channel Memory ¹⁶ Memory soldered down

16. All slots are non-accessible / non-upgradeable.

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 Wireless Card^{17,18}
Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 vPro Wireless Card ^{17,18}

WWAN

Intel 5000 5G Solution WWAN ^{19,20}
Intel XMM 7560 R+ LTE-Advanced Pro WWAN ¹⁹

NFC

Near Field Communications Controller

Miracast

Native Miracast Support 21

17. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

18. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

19. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

20. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network location, environment, network conditions, and other factors. Backwards

purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload are download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

21. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen Microphone/Headphone Combo Audio Jack

Camera

5MP MIPI-RAW Infrared with HP Camera Privacy Key



QuickSpecs

Technical Specifications

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, Spill-resistant keypad and optional backlit 22

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

F1 - Display Switching

F2 - Sure View or Blank

F3 - Brightness Down

F4 - Brightness Up

F5 - Speaker Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Backlight Toggle (for backlit keyboard) or Blank

F10 - Insert

F11 - Airplane Mode

F12 - Programmable Key

HP Camera Privacy Key

Power

Delete

22. Backlit keyboard is an optional feature.



SOFTWARE AND SECURITY

Software

HP Quick Touch

HP Ouick Drop 23

HP Easy Clean 24

HP PC Hardware Diagnostics Windows

myHP

HP Smart Support 25

HP Connection Optimizer

HP Hotkey Support

HP Support Assistant 26

HP Notifications

HP Privacy Settings

HP Power Manager

Buy Microsoft Office (Sold separately)

Manageability Features

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download) 27

HP Client Management Script Library (download)

HP Driver Packs (download)

HP Cloud Recovery 28

HP Client Catalog (download)

NOTE: To enhance brightness, level go to the Intel® Graphics Command Center app, click on System and turn off the Display Power Savings function.

Security Management

HP Wolf Security of Business 29 includes:

HP Sure Click 30

HP Sure Sense 31

HP Sure Run Gen5 32

HP Sure Recover Gen5 33

HP Sure Start Gen7 34

HP Tamper Lock

HP Sure Admin 35

HP Client Security Manager Gen7 36

BIOS

HP BIOSphere Gen6 37

HP Secure Erase 38

Absolute Persistence Module 39

HP DriveLock & Automatic DriveLock

BIOS Update via Network

HP Wake on WLAN

HP Fingerprint Sensor

Secured-Core PC Enable 40

TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)



QuickSpecs

Technical Specifications

Security TPM

Model: Infineon SLB9672VU2.0

Version: 15.21 Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

IPv6 Support

Yes

FirstNet Certified

No

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: Class 3

- 23. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
- 24. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.
- 25. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
- 26. HP Support Assistance requires Windows and Internet Access.
- 27. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

- 28. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: https://support.hp.com/us-en/document/c05115630.
- 29. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.
- 30. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.
- 31. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.
- 32. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.
- 33. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.
- 34. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher.
- 35. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from
- http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- 36. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.
- 37. HP BIOSphere Gen6 features may vary depending on the platform and configuration.
- 38. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-
- 88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.



39. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

40. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

POWER

Power Supply

HP 100W+10W USB-C+USB-A Slim Straight AC Power Adapter ⁴¹ HP Smart 65 W USB Type-C adapter ⁴¹ HP Smart 65 W Slim USB Type-C adapter ⁴¹

Battery

45Whr Long Life Polymer Fast Charge 4 cell Battery ^{42,43,44} 68Whr Long Life Polymer Fast Charge 6 cell Battery ^{42,43,44,45} Compliant with UL 1642 Standard

Power Cord

3-wire plug - 1m 41

Battery Life

Up to 19 hours 30 minutes (68 Whr battery) ⁴⁶ Up to 12 hours 45 minutes (45 Whr battery) ⁴⁶

- 41. Availability may vary by country.
- 42. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 43. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.
- 44. Recharges your battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 and 100 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 45. 68 Whr battery requires 100W AC adapter to support Fast Charge
- 46 Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.



WEIGHTS & DIMENSIONS

Product Weight ⁴⁷ 2.2 lbs 0.99 kg

Product Dimensions (W x D x H)

11.7 x 8.67 x 0.64 in 29.74 x 22.04 x 1.64 cm

47. Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

2 Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) 48

1 SuperSpeed USB Type-A 5Gbps signaling rate (Charging port) (USB 3.2 Gen 1)

1 Headphone/microphone combo jack

1 HDMI 2.0 49

1 Nano Security Lock Slot (Lock sold separately)

1 nano SIM card slot (WWAN Configurations Only)

48. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

49. HDMI cable sold separately.

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 50

50. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



QuickSpecs

Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements

(AC Power)

Nominal Operating Voltage AC 20V -> 68W battery

AC 15V -> 45W battery

Average Operating Power

Integrated graphics Yes **Discrete Graphics** N/A

Max Operating Power UMA<65W

Temperature

32° to 95° F (0° to 35° C) (not writing optical) Operating 41° to 95° F (5° to 35° C) (writing optical) Non-operating

Relative Humidity

Operating 32° to 95° F (0° to 35° C) (not writing optical)

5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature Non-operating

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

Random Vibration

Operating 1.043 grams Non-operating 3.5 grams

Altitude (unpressurized)

-50 to 10,000 ft (-15.24 to 3,048 m) Operating Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard

Certifications

HSN-I50C Regulatory Model Number UL Yes CSA Yes **FCC** Compliance Yes

ENERGY STAR® Yes 51

EPEAT® EPEAT® Gold in United States 52

Yes

TCO certified Yes **ICES** Yes Australia /NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes

KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes

CIT Yes **EAC Certificate** Yes

SABS Yes

Saudi Arabian Compliance (ICCP)



51. Configurations of the HP Elite Dragonfly 13.5 inch G3 Notebook PC that are ENERGY STAR® qualified are identified as HP Elite Dragonfly 13.5 inch G3 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.

52. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

13.5" WUXGA+
(1920 x 1280) Anti-Glare
UWVA WLED+LBL sRGB
NB2Y 1000 eDP 1.3+PSR
100 PrivacyG4 Plus bent
LCD Panel

 Outline Dimensions (W x H x D)
 290.200 x199.970 (max)

 Active Area
 284.890 x 189.930 (typ)

Weight 225 (max)
Diagonal Size 13.5

Thickness 2.2 / 3.9 (max)

InterfaceeDP 1.3Surface TreatmentAnti-Glare

Touch Enabled No

Contrast Ratio 1500:1 (typ)
Refresh Rate 60 Hz
Brightness 1000 nits

Pixel resolution - Format 1920 x1280 (WUXGA+)

Pixel Resolution – ConfigurationRGBBacklightWLEDColor Gamut CoveragesRGB 100%

Color Depth 8

Viewing Angle UWVA 85/85/85

Low Blue Light Yes
Power Consumption (W, EBL@ NA

150nits max/ 200nits max)

13.5" WUXGA+ (1920 x 1280) BrightView UWVA WLED+LBL sRGB NB2Y 400 eDP 1.4+PSR Low-Power 100 bent LCD Panel

 Outline Dimensions (W x H x D)
 290.190 x 199.730 (max)

 Active Area
 284.890 x 189.930 (typ)

Weight 200 (max)
Diagonal Size 13.5

Thickness 2.1 / 3.9 (max)

InterfaceeDP 1.4Surface TreatmentBright View

Touch Enabled No

Contrast Ratio 1500:1 (typ)
Refresh Rate 60 Hz



Brightness 400 nits

Pixel resolution - Format 1920 x 1280 (WUXGA+)

Pixel Resolution – Configuration RGB

Backlight WLED

Color Gamut Coverage sRGB 100%

Color Depth 8

Viewing Angle UWVA 89/89/89

Low Blue Light Yes

Power Consumption (W, EBL@ 150nits max/ 200nits max)

1.42 (max) / 1.71 (max)

13.5" 3k2k

(3000x+G64:G882000)
BrightView OLED UWVA DCIP3 100percent cg 400nits
eDP 1.4+PSR NBZ2
ultraslim Touch

Outline Dimensions (W x H x D) 289.430 x 199.620 (max)

Active Area 285.300 x 190.200 (typ)

Weight 154 (max)
Diagonal Size 13.5

Thickness 1.242 / 3.242 (max)

Interface eDP 1.4
Surface Treatment BrightView
Touch Enabled Yes¹

Contrast Ratio 100,000:1(typ)

Refresh Rate 60 Hz
Brightness 400 nits ¹

Pixel resolution - Format 3000 x 2000 (3k2k)

Pixel Resolution – ConfigurationRGBBacklightOLED

Color Gamut Coverage DCI P3 100%

Color Depth 8

Viewing Angle UWVA 85/85/85

Low Blue Light Yes

Power Consumption (W, EBL@ 150nits max/ 200nits max)

4.15 (max) / 4.93 (m+H88+G85:G88

13.5" WUXGA+
(1920 x 1280) Anti-Glare
UWVA WLED+LBL sRGB
NB2Y 1000 eDP 1.3+PSR
100 PrivacyG4 Plus bent
LCD Panel Touch

 Outline Dimensions (W x H x D)
 290.200 x199.970 (max)

 Active Area
 284.890 x 189.930 (typ)

Weight 225 (max)
Diagonal Size 13.5

Thickness 2.2 / 3.9 (max)

InterfaceeDP 1.3Surface TreatmentAnti-Glare



Touch Enabled Yes¹

Contrast Ratio 1500:1 (typ)
Refresh Rate 60 Hz
Brightness 1000 nits¹

Pixel resolution - Format 1920 x1280 (WUXGA+)

Pixel Resolution – Configuration RGB

Backlight WLED

Color Gamut Coverage sRGB 100%

Color Depth 8

Viewing Angle UWVA 85/85/85

Yes

NA

Low Blue Light
Power Consumption (W, EBL@
150nits max/ 200nits max)

13.5" WUXGA+ (1920 x 1280) BrightView UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel Touch Outline Dimensions (W x H x D) 29

Active Area

290.200 x199.970 (max) 284.890 x 189.930 (typ)

Weight 225 (max)
Diagonal Size 13.5

Thickness 2.2 / 3.9 (max)

InterfaceeDP 1.3Surface TreatmentBrightViewTouch EnabledYes1

Contrast Ratio1500:1 (typ)Refresh Rate60 HzBrightness1000 nits1

Pixel resolution - Format 1920 x1280 (WUXGA+)

Pixel Resolution – ConfigurationRGBBacklightWLEDColor Gamut CoveragesRGB 100%

Color Depth 8

Viewing Angle UWVA 85/85/85

Low Blue Light Yes
Power Consumption (W, EBL@ NA
150nits max/ 200nits max)



13.5" WUXGA+
(1920 x 1280) Anti-Glare
UWVA WLED+LBL sRGB
NB2Y 400 eDP 1.4+PSR
Low-Power 100 bent LCD
Panel Touch

 Outline Dimensions (W x H x D)
 290.190 x 199.730 (max)

 Active Area
 284.890 x 189.930 (typ)

Weight 200 (max)
Diagonal Size 13.5

Thickness 2.1 / 3.9 (max)

Interface eDP 1.4
Surface Treatment Anti-Glare
Touch Enabled Yes¹

Contrast Ratio1500:1 (typ)Refresh Rate60 HzBrightness400 nits1

Pixel resolution - Format 1920 x 1280 (WUXGA+)

Pixel Resolution – ConfigurationRGBBacklightWLEDColor Gamut CoveragesRGB 100%

Color Depth 8

Viewing Angle UWVA 89/89/89

Low Blue Light Yes

Power Consumption (W, EBL@ 1.42 (max) / 1.71 (max) 150nits max/ 200nits max)

13.5" WUXGA+ (1920 x 1280) BrightView UWVA WLED+LBL sRGB NB2Y 400 eDP 1.4+PSR Low-Power 100 bent LCD Panel Touch

 Outline Dimensions (W x H x D)
 290.190 x 199.730 (max)

 Active Area
 284.890 x 189.930 (typ)

Weight 200 (max)
Diagonal Size 13.5

Thickness 2.1 / 3.9 (max)
Interface eDP 1.4
Surface Treatment Bright View
Touch Enabled Yes¹

Contrast Ratio1500:1 (typ)Refresh Rate60 HzBrightness400 nits 1

Pixel resolution - Format 1920 x 1280 (WUXGA+)

Pixel Resolution – ConfigurationRGBBacklightWLEDColor Gamut CoveragesRGB 100%

Color Depth 8

Viewing Angle UWVA 89/89/89

Low Blue Light Yes

Power Consumption (W, EBL@ 1.42 (max) / 1.71 (max) 150nits max/ 200nits max)



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 11 and 10) is reserved for system recovery software.

SSD 256GB 2280 PCIe-4x4 NVMe Three Laver Cell Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCle NVMe Gen4X4

 Maximum Sequential Read
 4000 MB/s ±20%

 Maximum Sequential Write
 2000 MB/s ±20%

 Logical Blocks
 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

Maximum Sequential Write3500 MB/s ±20%Logical Blocks1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Pead
 6400 MR/s +20%

 $\begin{tabular}{ll} \mbox{Maximum Sequential Read} & 6400 \mbox{ MB/s $\pm 20\%$} \\ \mbox{Maximum Sequential Write} & 5000 \mbox{ MB/s $\pm 20\%$} \\ \end{tabular}$

Logical Blocks 2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280
Capacity 2TB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

 Maximum Sequential Write
 5000 MB/s ±20%

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

4,000,797,360

Features Pyrite 2.0; TRIM; L1.2

256GB PCIe-4x4 2280 NVME Form Factor
Self Encrypted OPAL2 Capacity
Three Layer Cell Solid State
Drive NAND Type

Form Factor M.2 2280
Capacity 256GB
NAND Type TLC

Logical Blocks

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 4000 MB/s ±20%

 Maximum Sequential Write
 2000 MB/s ±20%

 Logical Blocks
 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Form Factor
Self Encrypted OPAL2 Capacity
Three Layer Cell Solid State
Drive NAND Type

Form Factor M.2 2280
Capacity 512GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen4X4

 Maximum Sequential Read
 6400 MB/s ±20%

Maximum Sequential Write 3500 MB/s ±20% Logical Blocks 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2



SSD 256GB 2230 PCIe NVMe $\,$ Form Factor $\,$

Value

Form Factor M.2 2230
Capacity 256 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCle NVMe Gen3X4

 Maximum Sequential Read
 1500MB/s ±20%

 Maximum Sequential Write
 750MB/s ±20%

 Logical Blocks
 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite, TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Form Factor

Value

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 1500 MB/s ±20%

 Maximum Sequential Write
 750 MB/s ±20%

 Logical Blocks
 1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2



NETWORKING/COMMUNICATIONS

Intel® AX211 Wi-Fi 6E + Wireless LAN Standards
Bluetooth® 5.3 M.2
160MHz CNVi WW WLAN
vPro® Wireless Card^{1,5}

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11i
IEEE 802.11r
IEEE 802.11v
Wi-Fi certified

IEEE 802.11a

Interoperability Wi-Fi certified

Frequency Band •802.11b/g/n/ax

2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz

6.535 – 6.875 GHz 6.895 – 7.115 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac: 1733Mbps802.11ax: max 2.4Gbps

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11i

WAPI

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +17dBm minimum



• 802.11g : +16dBm minimum • 802.11a : +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
 802.11n HT40(2.4GHz): +13dBm minimum
 802.11n HT20(5GHz): +14dBm minimum

802.11n H120(5GHz): +14dBm minimum
 802.11n HT40(5GHz): +13dBm minimum
 802.11ac VHT80(5GHz): +10dBm minimum
 802.11ac VHT160(5GHz): +10dBm minimum
 802.11ac VHT40(2 4GHz): +12dBm minimum

802.11ax HE40(2.4GHz): +12dBm minimum
 802.11ax HE80(5GHz): +10dBm minimum
 802.11ax HE160(5GHz): +10dBm minimum

Power Consumption • Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW
 Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ • 802.11b, 1Mbps : -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n. MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum
802.11ac, MCS9(VHT80): -59dBm maximum
802.11ac, MCS9(VHT160): -58.5dBm maximum
802.11ax, MCS11(HE40): -57dBm maximum
802.11ax, MCS11(HE80): -54dBm maximum
802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8g

2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED OFF – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Number of AvailableLegacy : 0~79 (1 MHz/CH)ChannelsBLE : 0~39 (2 MHz/CH)

Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software

Microsoft Windows ACPI, and USB Bus Support

Power Management

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles
Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Laver

> LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 —Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising



2Mbps LE LE Long Range

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation)
- 5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 M.2 160MHz CNVi WW WLAN non-vPro® Wireless Card ¹		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11b IEEE 802.11t IEEE 802.11h IEEE 802.11i IEEE 802.11i IEEE 802.11r IEEE 802.11r
	Interoperability	Wi-Fi certified
	Frequency Band	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac: 1733Mbps 802.11ax: max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum



OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certificationWPA3 certificationIEEE 802.11i

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +17dBm minimum

802.11g: +16dBm minimum802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
802.11n HT40(2.4GHz): +13dBm minimum
802.11n HT20(5GHz): +14dBm minimum
802.11n HT40(5GHz): +13dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum
802.11ac VHT160(5GHz): +10dBm minimum
802.11ax HE40(2.4GHz): +12dBm minimum
802.11ax HE80(5GHz): +10dBm minimum

Power Consumption

Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode 50 mW (WLAN unassociated)

802.11ax HE160(5GHz): +10dBm minimum

Connected Standby 10mW

Radio disabled 8 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴

802.11b, 1Mbps: -93.5dBm maximum
 802.11b, 11Mbps: -84dBm maximum
 802.11a/g, 6Mbps: -86dBm maximum

802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum

802.11ac, MCS0(VHT80): -84dBm maximum
802.11ac, MCS9(VHT80): -59dBm maximum
802.11ac, MCS9(VHT160): -58.5dBm maximum
802.11ax, MCS11(HE40): -57dBm maximum
802.11ax, MCS11(HE80): -54dBm maximum
802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

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2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8g

2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

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Altitude Operating 0 to 10,000 ft (3,048 m)

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Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy : 0~79 (1 MHz/CH)
Channels BLE : 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software

Supported Link Topology

Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management

Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Software

BT4.1-ESR 5/6/7 Compliance

Supported LE Link Layer Ping

LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy



LE Privacy 1.2 —Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2

Headset Profile (HSP)

Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

LE Advertisement Extensions

Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE

LE Long Range

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
- 5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.



Intel® 5G Solution 5000¹

Technology/Operating bands

WCDMA/HSPA+ operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL). 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) LTE FDD/TDD operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL) Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL) Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) Band 29: 717 to 728 MHz (DL) Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL) Band 32: 1452 to 1496 MHz (DL) Band 34: 2010 to 2025 MHz (UL/DL) Band 38: 2570 to 2620 MHz (UL/DL) Band 39: 1880 to 1920 MHz (UL/DL) Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 43: 3400 to 3800 MHZ (UL/DL) Band 46: 5150 to 5925 MHZ (DL) Band 48: 3550 to 3700 MHZ (UL/DL) Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) 5GNR Sub 6GHZ n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) n38: 2570 to 2620 MHz (UL/DL) n40: 2300 to 2400 MHz (UL/DL) n41: 2496 to 2690 MHz (UL/DL) n48: 3550 to 3700 MHZ (UL/DL) n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) n77: 3300 to 4200 MHz (UL/DL)



n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL)

Wireless protocol standards 5GNR Air Interface

3GPP Rel15 5G NR sub-6

LTE Rel14

20 layers and 2 Gbps downlink (DL) throughput -4×4 MIMO across

5x CA

200 Mbps/uplink (UL) throughput - 40 MHz ULCA and 256 QAM

WCDMA R99,

3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B)

GPS bands GPS: L1 (1575.42MHz)

GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) OZSS(1575.42 MHz)

Maximum data rates SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps

5G NSA sub 6G: DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL: 1.6 Gbps) ue-CategoryUL 13, (UL: 150Mbps)

DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm

NR: 23 dBm in all band except n41, n77, n78 and n79

LTE n41, n77, n78 and n79 HPUE = 26dBm

HSPA+: 23.5 dBm 5G Sub 6 : 2500 mA

Maximum power 5G Sub 6: 2500 mA

consumption LTE: 1,300 mA (peak); 1100 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 8 g

Dimensions 52 mm × 30 mm × 2.6 mm

(Length x Width x Thickness)

eSIM Support

1. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.



Intel® XMM™ 7560 R+ LTE-Advanced Pro1

Technology/Operating

bands

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only).

2300 (Band 30), 1700/2100 (Band 66), 600 (band 71).

TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48).

5200 (Band 46 RX only) MHz;

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol

standards

3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to

150Mbps

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098

MHz

Maximum data rates LTE: 978 Mbps (Download), 150 Mbps (Upload)

42 x 30 x 2.3 mm

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

> LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm

Maximum power LTE: 1.200 mA (peak): 900 mA (average) consumption HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 q

Dimensions (Length x Width x

Thickness)

eSIM

1. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions.

Support



Near Field Communications Controller (optional) Dimensions (L x W x H)

Module 25 mm by 10 mm by 2.0 mm

Chipset

NPC100

I2C

System interface

NFC RF standards

ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support

Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD)

Mode (1)

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

ISO/IEC 14443 A

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-VICC) Mode (1) ISO/IEC 14443 A ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer 106, 212, 424, 848 kbps

Operating temperature 0°C to 70°C

Storage temperature -20°C to 125°C

Humidity 10-90% operating 5-95% non-operating

Supply Operating voltage 4.35 to 5.25 Volts

I/O Voltage 1.8V or 3.3V

Power Consumption

(Booster enable, VBAT= 3.3V, VCC_BOOST = 5V)

Mode Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.



POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

AC Adapter 65 Watt nPFC
Slim USB type C Straight
1.8m

Dimensions	(H x	W	X	D)
Weight				

88x53.5x21mm unit: 220g +/- 10g

Input

Input Efficiency

81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range

47 ~ 63 Hz

65W

Input AC current

1.6 A at 90 VAC and maximum load

Output **Output power**

> DC output 5V/9V/12V/15V/20V Hold-up time 5ms at 115 Vac input

Output current limit <8.0A

Connector USB Type C

Environmental Design

Operating 32°Fto 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°Fto 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 5% to 95% **Storage Humidity** 5% to 95%

EMI and Safety Certifications

Eg:

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV:

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Dimensions (H x W x D) Standard USB type C Straight 1.8m

90.0 x 51 x 28.5 mm unit: 250g +/- 10g

Weight Input

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:88% 15V:88% 20V:89%

Input frequency range 47 ~ 63 Hz



Input AC current Max. 1.6 A at 90 Vac

Output Output power 65W

DC output 5V/9V/12V/15V/20V
Hold-up time 5ms at 115 Vac input

Output current limit <8.0A

Connector USB TYPE C

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Eg: Certifications *CE

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 100W+10W Slim USB-C+USB-A Straight AC Power Adapter Kenting ¹

Dimensions (H x W x D)

Weight

Input

136 x 60 x 22mm

unit: 365g +/- 10g

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5VusbA: 73.62% 5VusbC: 81.5% 9V: 86.7% 12V: 88% 15V: 89%

20V:89%

> 90% efficiency at 100W (20V/5A) output

condition

Input frequency range 47 ~ 63 Hz

Input AC current 1.6 A at 90 VAC and maximum load

Output Output power 110V

DC output 5VusbA/5V/9V/12V/15V/20V

Hold-up time 5ms at 115 Vac input

Output current limit <6.25A

Connector USB Type C

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 5% to 95% **Storage Humidity** 5% to 95%

EMI and Safety

Certifications *CE Mark - full compliance with LVD and EMC directives

> * Worldwide safety standards - IEC60950-1 and/or IEC62368-1. EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1,

SELV:

Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC

Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

1. 68 Whr battery requires 100W AC adapter to support Fast Charge

45Whr¹ Long Life Polymer Dimensions (H x W x D)

Weight 206.8q+/-10q

Fast Charge² 4 cell **Battery**

Cells/Type

4cell Lithium-Ion Polymer cell / 484283

Energy

7.72V Voltage

Amp-hour capacity Watt-hour capacity¹

282.9 x 107.25 x 5.9mm

5.909Ah 45.6Wh

Operating (Charging) **Temperature**

32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 122° F (-10° to 60° C)

N/A

Fuel Gauge LED

Same as product warranty Warranty

Optional Travel Battery

Available

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

2. Recharges your battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 and 100 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

68Whr¹ Long Life Polymer Dimensions (H x W x D)

282.9 x 110.65 x 5.9mm

Fast Charge^{2,3} 6 cell

Weight

300q+/-10q

Battery

Cells/Type 6cell Lithium-Ion Polymer cell / 484283

Energy Voltage 11.58V

> **Amp-hour capacity** 5.909 Ah

Watt-hour capacity¹ 68.4Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 122° F (-10° to 60° C)

Fuel Gauge LED N/A

Warranty Same as product warranty

Optional Travel Battery No

Available

- 1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
- 2. Recharges your battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 and 100 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 3. 68 Whr battery requires 100W AC adapter to support Fast Charge



AUDIO

HD Stereo Codec Realtek ALC3315

Audio I/O Ports Headset: CTIA only and Headphone-out

Internal Speaker Amplifier Cirrus Logic High-Efficiency Boosted Class D Amplifier

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow independent audio.

Following MSFT Behaviour

Sampling DAC:44.1k/48kHz

ADC:48kHz

Analog Audio Support 3.5mm Headset: CTIA only and Headphone-out

Internal Speaker Yes

FINGERPRINT READER

Sensor vendor Synaptics FS7604

Sensor type Capacitive DPI resolution 363DPI

Scan area 7.4x6mm sensor area

False Rejection Rate <1%

False Acceptance Rate 1:50K FAR
Mobile Voltage Operation 3.0V to 3.6V
Operating Temperature 0~60°C
Current Consumption 100mA Max

Image

Low Latency Wait For

Finger

Capture Rate <30msec per image

ESD Resistance IEC 61000-4-2 4B (+/-15KV)

Detection Matrix 363 dpi / 7.4x6mm sensor area

260 uA



QuickSpecs

Technical Specifications

ENVIRONMENTAL DATA

ENVIRONMENTAL DATA					
Eco-Label Certifications & declarations Sustainable Impact Specifications	may be labeled with one of IT ECO declaration US ENERGY STAR® US Federal Energy EPEAT® Gold regis status in your courtified China Energy Conse China State Environe Taiwan Green Mare Korea Eco-label Japan PC Green la Ocean-bound plastic in Secondary 10% post-consumer recy 85% recycled metal	r more of these marks: n y Management Program (FE stered in the United States. Intry. servation Program (CECP) conmental Protection Admin rk bel* peaker	See http://www.epeat.net for registration		
	 Low halogen Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable Bulk packaging available 				
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".				
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Sort	113VAC, OUIIZ	ZJUVAC, JUIIZ	100VAC, 30112		
idle)	7.17 W	7.06 W	7.08 W		
Normal Operation (Long					
idle)	0.77 W	0.73 W	0.78 W		
Sleep Off	0.77 W 0.44 W	0.73 W 0.46 W	0.78 W 0.44 W		
	model family. HP compute applicable U.S. Environmer computers. If a model fam energy efficiency data liste	rs marked with the ENERGY ntal Protection Agency (EPA ily does not offer ENERGY S	compliant product if offered within the YSTAR® Logo are compliant with the A) ENERGY STAR® specifications for STAR® compliant configurations, then ed PC featuring a hard disk drive, a high perating system.		
	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Heat Dissipation*	1101110,0011		1000110,0011		
Normal Operation (Short idle)	24.5 BTU/hr	24.1 BTU/hr	24.2 BTU/hr		
Normal Operation (Short idle) Normal Operation (Long	24.5 BTU/hr	24.1 BTU/hr	24.2 BTU/hr		
Normal Operation (Short idle)		-			



QuickSpecs

Technical Specifications

Declared Noise Emissions	Sound Power Sou			und Pressure	
(in accordance with ISO 7779 and ISO 9296)		(L _{WAd} , bels)	(L _{pAm} , decibels)		
Typically Configured – Idle		2.6	13.7		
Fixed Disk – Random writes		2.8	21.	21.2	
Optical Drive – Sequential reads		3.8	32.	32.6	
Longevity and Upgrading	This product can be upgraded, possibly extending its useful life by several years. Upgrafeatures and/or components contained in the Spare parts are available throughout the				
Additional Information	• This dire • This Equ	for up to "5" years after the end of production. product is in compliance with the Restrictions of Hazardous Substances (RoHS) tive - 2011/65/EC. HP product is designed to comply with the Waste Electrical and Electronic pment (WEEE) Directive – 2002/96/EC.			
	 This product is in compliance with California Proposition 65 (State of California; SDrinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold lewww.epeat.net Plastics parts weighing over 25 grams used in the product are marked per ISO11 ISO1043. This product is 96.9% recycle-able when properly disposed of at end of life. 				
Packaging Materials	External:	PAPER/Corrugated		261 g	
		PAPER/Paper		3 g	
		PAPER/Molded Pulp		111 g	
	Internal: PLASTIC/Polyethylene low		density - LDPE	14 g	
	The plastic packaging material contains at least 0.0% recycled cont			t.	
	The corruga	ted paper packaging materials	contains at least 53.4% rec	ycled content.	
RoHS Compliance	the restriction to our product legislation in We believe the limination of substances—	complies fully with materials regulations. We were among the first companies to extend rictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive roducts worldwide through the HP GSE. HP has contributed to the development of related ion in Europe, as well as China, India, and Vietnam. Eve the RoHS directive and similar laws play an important role in promoting industry-wide tion of substances of concern. We have supported the inclusion of additional inces—including PVC, BFRs, and certain phthalates—in future RoHS legislation that is to electrical and electronics products.			
We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to ex scope of the commitment to include further restricted substances as regulations contine evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.					
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.htm):				
 Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardant Cadmium Chlorinated Hydrocarbons 					



recrimeat specifica	
Packaging Usage	 Chlorinated Paraffins Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP) Dibutyl phthalate (DBP) Diisobutyl phthalate (DIBP) Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBS) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl (PCB) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyonyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly
	instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.

COUNTRY OF ORIGIN

China



Options and Accessories (Sold separately and availability may vary by country)

DOCKING (Sold Separately)

Dock Connectors

Docking station model #1

Total number of supported displays

(incl. the notebook display)
Max. resolutions supported

HP Thunderbolt Dock G2

Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported

Single 8K@ 30Hz (multiple tiles) for Thunderbolt hosts

Non-TBT hosts DP 1.4 in high res mode (1) 8K video single cable@30Hz [10]

2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode

Technical limitations Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running

Thunderbolt host.

Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host

or running a non-Thunderbolt host in High Resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in

multi-function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz +

(1) 4K UHD @ 30Hz.

Docking station model #2

Total number of supported displays

(incl. the notebook display) Max. resolutions supported

Dock Connectors
Technical limitations

HP USB-C Dock G5

3

Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode) [10]

1xHDMI. 2xDP

'echnical limitations Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution

mode.

Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one

4K UHD@ 30 Hz on HDMI in multi-function mode

The highest resolution for a non-Thunderbolt host in Multi-function mode is a

single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.

Docking station model #3

Total number of supported displays

(incl. the notebook display) Max. resolutions supported

Dock Connectors
Technical limitations

HP USB-C/A Universal Dock G2

3

Triple 4K UHD@ 60Hz [10]

1xHDMI, 2xDP

The best resolution for dual or triple displays is 4K UHD@ 60Hz.

For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from

the host

QuickSpecs

Options and Accessories (Sold separately and availability may vary by country)

Туре	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Executive 14.1 Slim Topload	6KD04AA
	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Renew Business 14.1" Bag	3E5F9AA
	HP Renew Business 14.1" Sleeve	3E2U7AA
	HP Renew Business 14.1" Sleeve	3E2U7AA
	HP Renew Business 14.1" Bag	3E5F9AA
	HP Renew Business 15.6" Bag	3E5F8AA
	HP Renew Business 15.6" Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock (Hook)	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio (HOOK+MIXMASTER)	3YE87AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable (Hook)	3TR87AA
	HP USB-C 120W G5 Dock (AdicoraA)	5TW10AA
	HP USB-C/A 120W G2 Universal Dock (Adicora-D)	5TW13AA
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB to Gigabit RJ45 Adapter	N7P47AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to DisplayPort Adapter	N9K76AA
	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA



Options and Accessories (Sold separately and availability may vary by country)

	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 65W USB-C Travel Slim Kermit AC Power Adapter	3PN48AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA



Change Log

Date of change:	Version History:		Description of change:
April 8, 2022	V1 to V2	Added	Reference for USB ports
April 22, 2022	V2 to V3	Added	Environmental Data
June 15, 2022	V3 to V4	Added	Added note in Manageability Feature
September 7, 2022	V4 to V5	Removed	Tile App
October 19, 2022	V5 to V6	Updated	Bluetooth version
December 7, 2022	V6 to V7	Updated	Windows OS
December 22, 2022	V7 to V8	Updated	Display section
January 20, 2023	V8 to V9	Updated	Operating System
February 6, 2023	V9 to V10	Updated	eSim support on Intel 5000 5G Solution
March 2, 2023	V10 to V11	Updated	Networking and communications section
March 14, 2023	V11 to V12	Updated	Environmental Data
	V12 to V13		

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